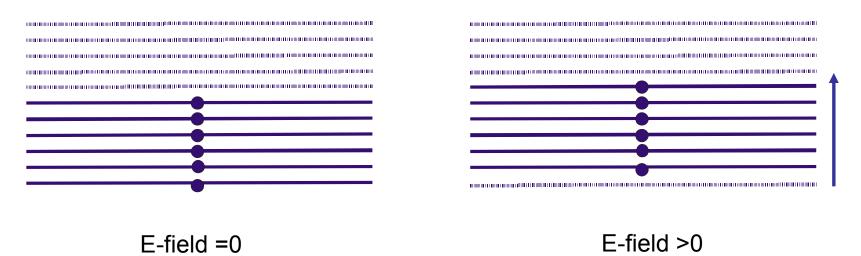


#### Conduction in a band

i) There must be free electrons, i.e. no conduction in an empty C.B
 ii) There needs to be a band of states. If carriers gain energy there must be a higher empty level available, otherwise Paulis's exclusion principle violated.

#### Consequences:

(a) an empty C.B. cannot support conduction(b) a completely full band cant support conduction either Band must be partially filled!



If electric field is applied, electrons gain energy and can move into higher energy empty states

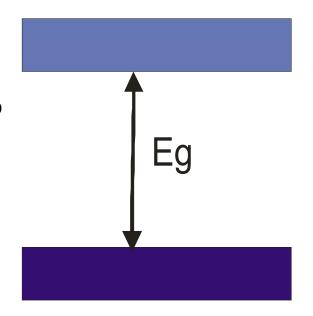


#### **Insulators**

Have a filled VB and a conduction band separated by a large energy gap (typically 5-20eV)

Only is electrons can acquire and energy E<sub>g</sub> can they move into the CB.

Thermal energy = kT~ 0.025eV at 300K so probability is small No (or very poor) conduction.



#### Metals

There electronic structure has a distinguishing feature.

Outer empty band overlaps the inner full band As a result, you have a composite band and an ideal situation for conduction.

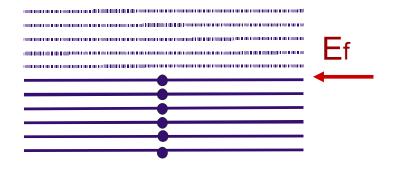
There is no energy gap. Electrons are free to move in an electric field to higher energy levels





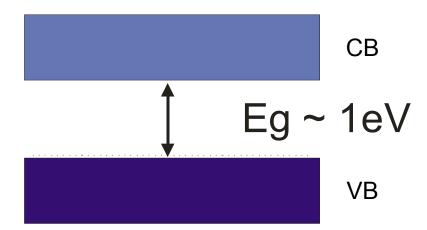
We can define a fill level, known as the **FERMI LEVEL** 

At OK, levels above the Fermi level are empty, levels below are full



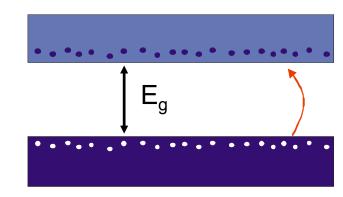
In a **Semiconductor** the energy gap (Eg) ~ 1eV At low temperature electrons cannot reach the CB: INSULATOR

Thermal energy = kT~ 0.025eV at 300K So Eg> kT, but there is a now finite possibility of some electrons in the CB



Energy gap is sufficiently small that electrons can be promoted to the conduction band.

Each electron promoted to the CB leaves behind one vacant level (hole) in the VB. Conduction in semiconductors is due to:



- (i) electrons moving in the part filled CB
- (ii) electrons in the VB moving into levels vacated by electrons elevated into the CB. Easier to view as the movement of holes

In an intrinsic semiconductor:

number of electrons = n (m-3) = number of holes = p (m-3)=  $n_i$  (intrinsic concentration)

#### Intrinsic Semiconductor

Know that  $\mathbf{n} = \mathbf{p} = \mathbf{n_i}$ . Need  $\mathbf{n_i}$  to determine the no. of electrons (holes) and then determine the conductivity ( $\delta$ )

Since there are a large number of electrons (typ. 10<sup>28</sup>m<sup>-3</sup>) in a semiconductor, we cant determine the conduction of every electron. However we can look at all the electrons statistically and determine the average behaviour of electrons

To help us, we define a probability distribution function called the

#### FERMI-DIRAC function) P(E)

Function P(E) gives the *probability* that an electron has an energy E (at some temperature T).

e.g. If  $P(E_1) = 0.2$ , 20% of electrons have  $E = E_1$ 

The statistics that govern detailed form of P(E) depend on

- 1) type of particle
- 2) How these particles interact

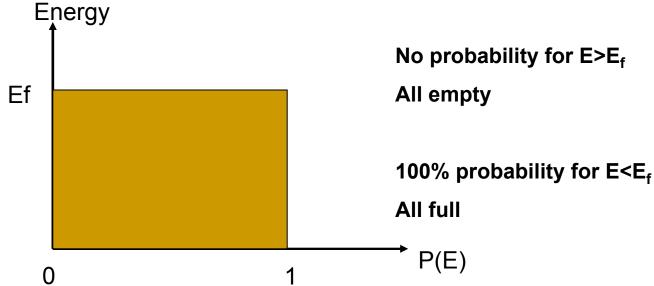
If non interacting (e.g.: gas molecules) then they would be governed by Boltzmann statistics In this case the particles are electrons and are governed by Fermi-Dirac statistics i.e.: they must obey the Pauli exclusion principle

$$P(E) = \frac{1}{1 + e^{\frac{E - Ef}{kT}}}$$
 Where E<sub>f</sub> is the Fermi level

P(E) is the probability that an electron has an energy E. P(E) varies from 0 to 1.

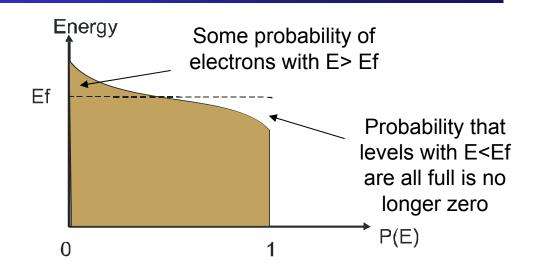
Two examples, at T=0K

E>E<sub>f</sub> 
$$P(E) = \frac{1}{1 + e^{-\infty}} = 0$$
 EP(E) = \frac{1}{1 + e^{-\infty}} = 1



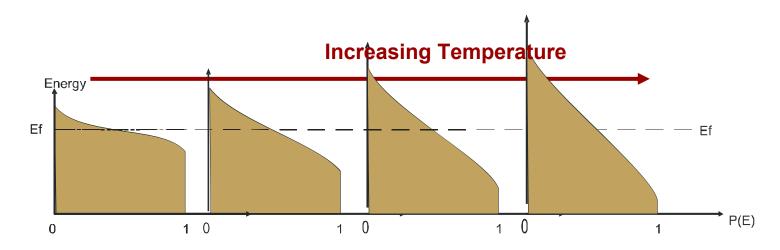
# So what happens at higher temperature?

At T>0K there is always some possibility that electrons can have a higher energy than  $E_{\rm f}$ . There probability will be higher the closer they are to  $E_{\rm f}$ 

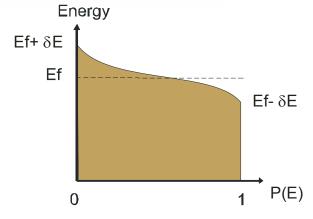


Actual shape of P(E) depends on the function

As T increases the probability of E>  $E_f$  also increases, but P(E) is always symmetrical about  $E_f$ 





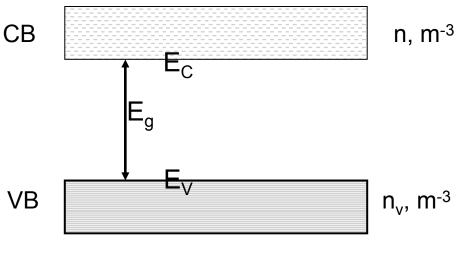


$$P(E_f + \delta E) = 1 - P(E_f - \delta E)$$

Apply to Semiconductor

Probability that an electron can gain enough energy to reach the CB is the probability that it can have energy  $E_v+E_\alpha$ 

Probability of an electron in the VB, energy  $\mathsf{E}_\mathsf{v}$ 



$$P(E_v + E_g) = \frac{1}{1 + e^{\frac{E_v + E_g - Ef}{kT}}}$$

If we assume n electrons in the CB at a temperature T and we have  $n+n_v=n_{Tot}$  electrons in total, then

$$n = n_{Tot} P(E_v + E_g)$$

Probability of electrons in CB is:

$$n = \frac{n_{Tot}}{1 + e^{\frac{E_v + E_g - Ef}{kT}}}$$

Probability of electrons in VB is:

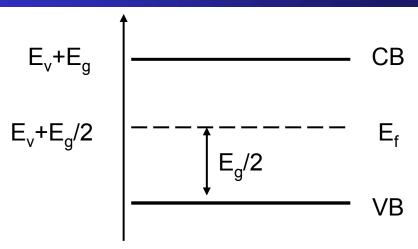
$$n_{v} = \frac{n_{Tot}}{1 + e^{\frac{E_{v} - Ef}{kT}}}$$

We know that  $n_{Tot} = n + n_V$ 

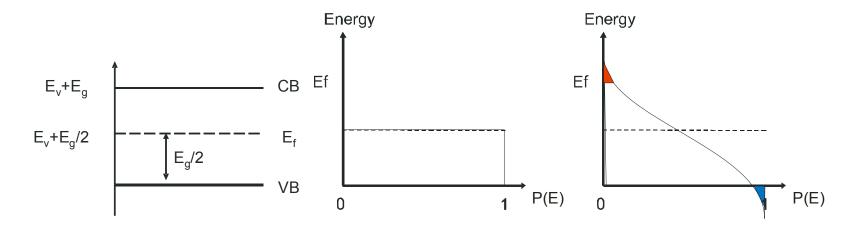
$$n_{Total} = \frac{n_{Tot}}{1 + e^{\frac{E_v + E_g + E_f}{kT}}} + \frac{n_{Tot}}{1 + e^{\frac{E_v - Ef}{kT}}}$$

Solution is  $E_f = E_g/2$ .

In an INTRINSIC semiconductor, they Fermi level is mid way between the CB and the VB (mid gap)



As the temperature increases the probability that an electron occupies the CB increases. Always  $n = p = n_{i,}$  so we always have the same concentration of electrons as holes





$$n_i = \frac{n_{Tot}}{1 + e^{\frac{E_v + E_g - E_v - \frac{E_g}{2}}{kT}}}$$

$$n_i = \frac{n_{Tot}}{1 + e^{\frac{Eg}{2kT}}}$$

### Semiconductors have different band gaps (E<sub>g</sub>)

Material	Energy gap (eV)	
	0K	300K
Si	1.17	1.11
31	1.17	1.11
Ge	0.74	0.66
InSb	0.23	0.17
InAs	0.43	0.36
InP	1.42	1.27
GaP	2.32	2.25
GaAs	1.52	1.43
GaSb	0.81	0.68
CdSe	1.84	1.74
CdTe	1.61	1.44
ZnO	3.44	3.2
ZnS	3.91	3.6

As  $E_g$  increases,  $n_i$  decreases exponentially  $n_i \sim \exp(-E_g)$ 

As T increases,  $n_i$  increases exponentially  $n_i \sim \exp(-1/T)$ 

Need a 'useful'  $n_i$ , therefore useful  $E_g$  are in the range 0.1 to a few eV

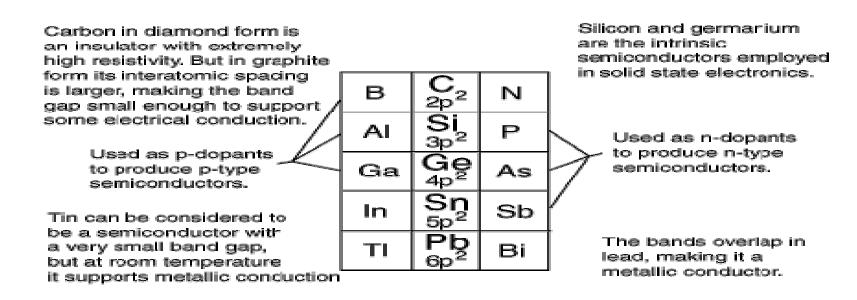
Semiconductors are very temperature sensitive and device parameters can change a lot



#### **Doped semiconductors**

Intrinsic semiconductors are rarely used in practice since  $\sigma$  = F(Temp) only.

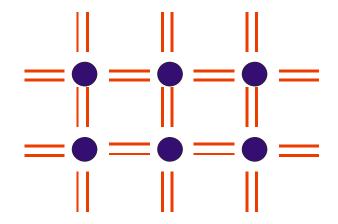
However we can vary the  $\sigma$  by using **doping** (also known as extrinsic semiconductors)



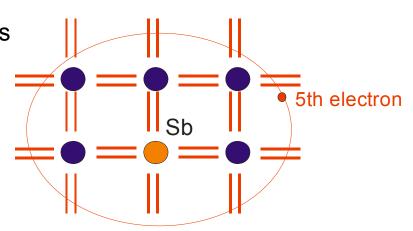


#### n-type

Intrinsic (parent) material is Si. Has 4 electrons and 4 vacancies in the outer shell. Covalently bonded in diamond type structure.



We can add to the silicon n-type donors, such as phosphorus (P), arsenic (As), antimony (Sb), all have 5 electrons and 3 vacancies in outer shell. Dopant atoms substitute at Si site.



Only 4 electrons taken up as covalent bonds. The extra electron loosely bound to parent donor at 0K.

The extra electron behaves like a hydrogen (Bohr) atom except:

- (i) Its mass (me) is different:  $me \rightarrow me$
- ii)  $e_0 \rightarrow e = e_0 e_r$  since its orbit is in a dielectric e.g. Si

#### Hydrogen Bohr Model

$$E_{i} = \frac{me^{-4}}{8 \varepsilon_{0}^{2} h^{2} n^{2}} = \frac{13 \cdot 6 eV}{n^{2}}$$

$$E_{i} = \frac{13 \cdot 6 m \cdot e^{*}}{\varepsilon \cdot r \cdot m}$$

For Si  $\varepsilon$ r ~ 16,  $m_e^*/m = 0.6$ assume n=1

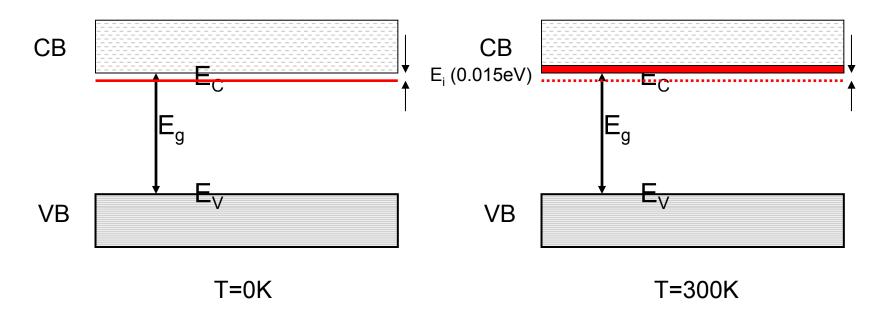
#### For Si, it predicts $E_i = 0.03eV$ . Actually we observe 0.015eV

At most temperatures, kT> $\epsilon_i$ ; (kT @ RT(300K) ~0.025 eV)

So at RT all donors are ionised (free, mobile). Each donor contributes 1 electron to C.B.

#### n=N<sub>d</sub> (the donor density)

But no extra holes produced in V.B, so not like intrinsic



So  $\sigma = f(Nd) \neq f(T)$  provided all Nd's are ionised, e.g. at RT Also small levels of dopant increase  $\sigma$  a lot.

e.g. intrinsic Si, ni = n = p =  $10^{16}$  m<sup>-3</sup> at RT

We can easily dope to higher levels than this

Dope the Silicon with 1 part in 10<sup>6</sup> with phosphorus donors. Si has 10<sup>28</sup> atoms per m<sup>3</sup>

$$N_d = \frac{10^{-28}}{10^{-6}} = 10^{-22} m^{-3} = n$$

n = N<sub>d</sub>, so 
$$\frac{\sigma_n}{\sigma_i} \approx \frac{n}{n_i} = \frac{10^{-22}}{10^{-16}} = 10^{-6}$$

One important rule for semiconductors,  $\mathbf{n} \mathbf{p} = \mathbf{n_i}^2$ 

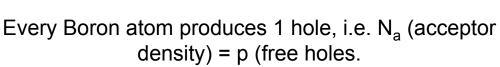
$$p = \frac{n_i^2}{n} = \frac{(10^{-16})^2}{10^{-22}} = 10^{-10} << p_i (= 10^{-16})$$

Conductivity  $\sigma = n_e m_e + p_e m_h$ . Can ignore  $n_i$  and p in n-doped material

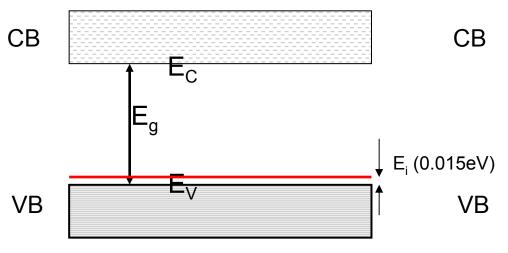


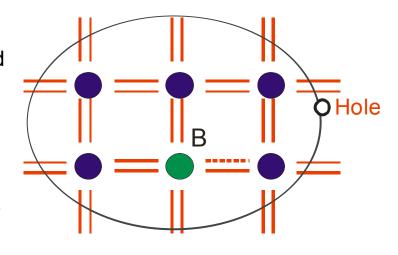
#### p-type semiconductors

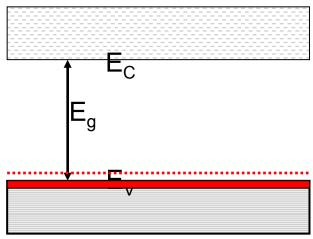
P-type dopants are called acceptors – 3 electrons and 5 vacancies in the outer shell, e.g. boron Vacancy or hole– loosely bound to parent atom – an electron can move into vacancy and create a hole. Energy needed again ~0.01eV.



$$p = N_a >> pi$$
. Again  $p = ni^2$ .  $n << n_i$ .  $\sigma p >> \sigma i$ 







$$T=0K$$
  $T=300K$ 



# Making Doped Silicon



+



Silicon (few Kg)

Phosphorus (few  $\mu g$ )



